

**Product Overview**

**Address Spaces**

**Addressing Modes**

**Memory Map**

**SAM47 Instruction Set**

# 1

## PRODUCT OVERVIEW

### OVERVIEW

The S3C7574 single-chip CMOS microcontroller has been designed for high performance using Samsung's newest 4-bit CPU core, SAM47 (Samsung Arrangeable Microcontrollers).

With features such as, DTMF Generator, LCD direct drive capability, 8-bit timer/counter, and watch timer, the S3C7574 offers an excellent design solution for a wide variety of telecommunication applications that require LCD functions.

Up to 15 pins of the 64-pin QFP package, it can be dedicated to I/O. Four vectored interrupts provide fast response to internal and external events. In addition, the S3C7574's advanced CMOS technology provides for low power consumption and a wide operating voltage range.

### OTP

The S3C7574 microcontroller is also available in OTP (One Time Programmable) version, S3P7574. The S3P7574 microcontroller has an on-chip 4-Kbyte one-time-programmable EPROM instead of masked ROM. The S3P7574 is comparable to S3C7574, both in function and in pin configuration.

## FEATURES

### Memory

- 256 × 4-bit data RAM
- 32 × 4-bit display RAM
- 4096 × 8-bit ROM

### I/O Pins

- Input only: 4 pins
- I/O: 11 pins
- Output: 8 pins sharing with segment driver outputs

### LCD Controller/Driver

- Maximum 16-digit LCD direct drive capability
- 32 segment, 4 common pins
- Display modes: Static, 1/2 duty (1/2 bias)  
1/3 duty (1/2 or 1/3 bias), 1/4 duty (1/3 bias)

### 8-Bit Basic Timer

- Programmable interval timer
- Watchdog timer

### 8-Bit Timer/Counter

- Programmable 8-bit timer
- External event counter
- Arbitrary clock frequency output

### Watch Timer

- Real-time and interval time measurement
- Four frequency outputs to BUZ pin
- Clock source generation for LCD

### Bit Sequential Carrier

- Support 16-bit serial data transfer in arbitrary format

### DTMF Generator

- 16 Dual-tone frequencies for tone dialing applications (only 3.58 MHz)

### Interrupts

- Two internal vectored interrupts
- Two external vectored interrupts
- Two quasi-interrupts

### Memory-Mapped I/O Structure

- Data memory bank 15

### Two Power-Down Modes

- Idle mode (only CPU clock stops)
- Stop mode (main or sub system oscillation stops)

### Oscillation Sources

- Crystal, ceramic, or RC for main system clock
- Crystal or external oscillator for subsystem clock
- Main system clock frequency: 4.19 MHz (typical)
- Subsystem clock frequency: 32.768 kHz
- CPU clock divider circuit (by 4, 8, or 64)

### Instruction Execution Times

- 0.95, 1.91, 15.3  $\mu$ s at 4.19 MHz (main)
- 122  $\mu$ s at 32.768 kHz (subsystem)

### Operating Temperature

- -40 °C to 85 °C

### Operating Voltage Range

- 2.0 V to 5.5 V at 4.19 MHz
- 1.8 V to 5.5 V at 3 MHz

### Package Type

- 64-QFP-1420F
- 64-QFP-1414

## BLOCK DIAGRAM

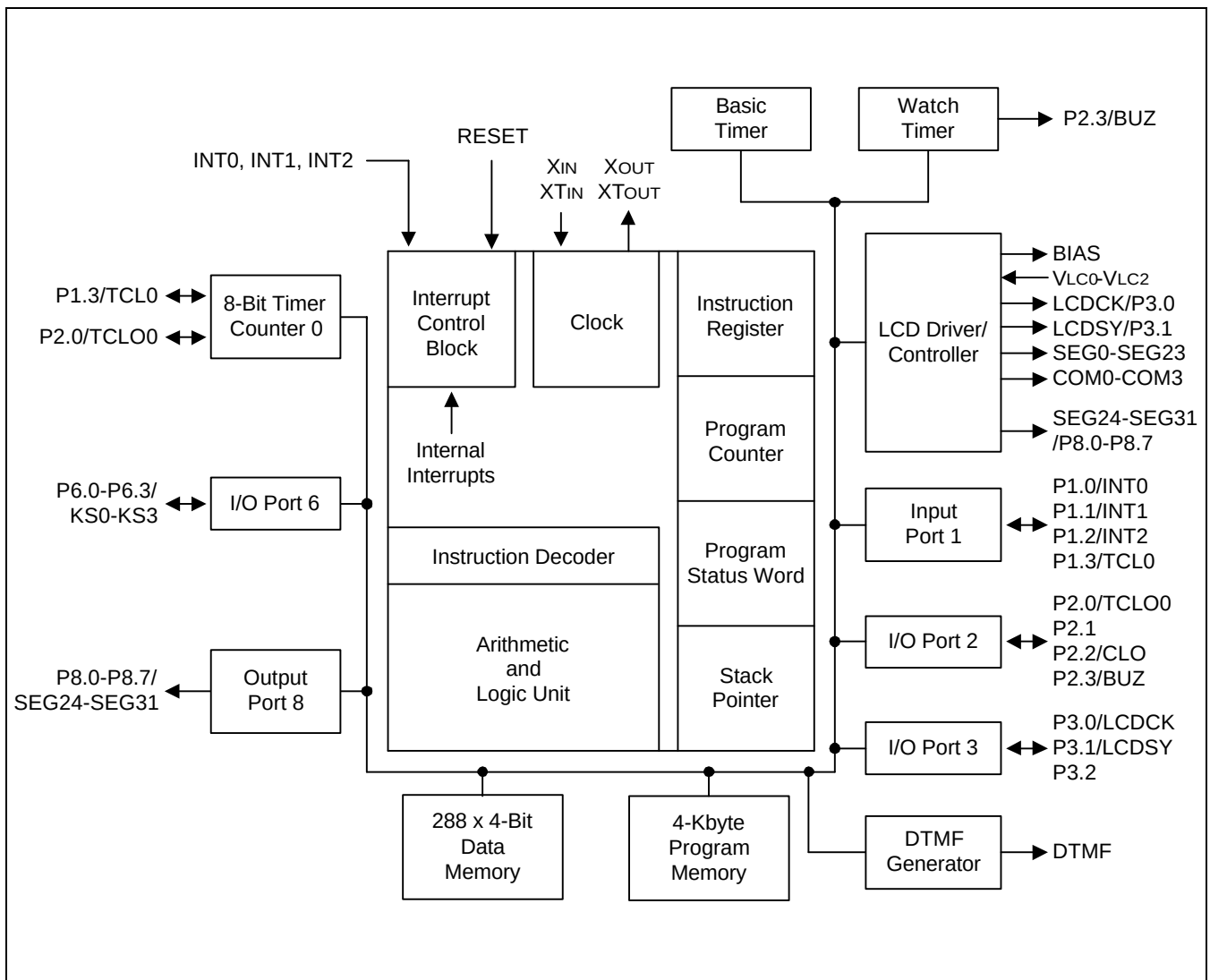


Figure 1-1. S3C7574 Simplified Block Diagram

PIN ASSIGNMENTS

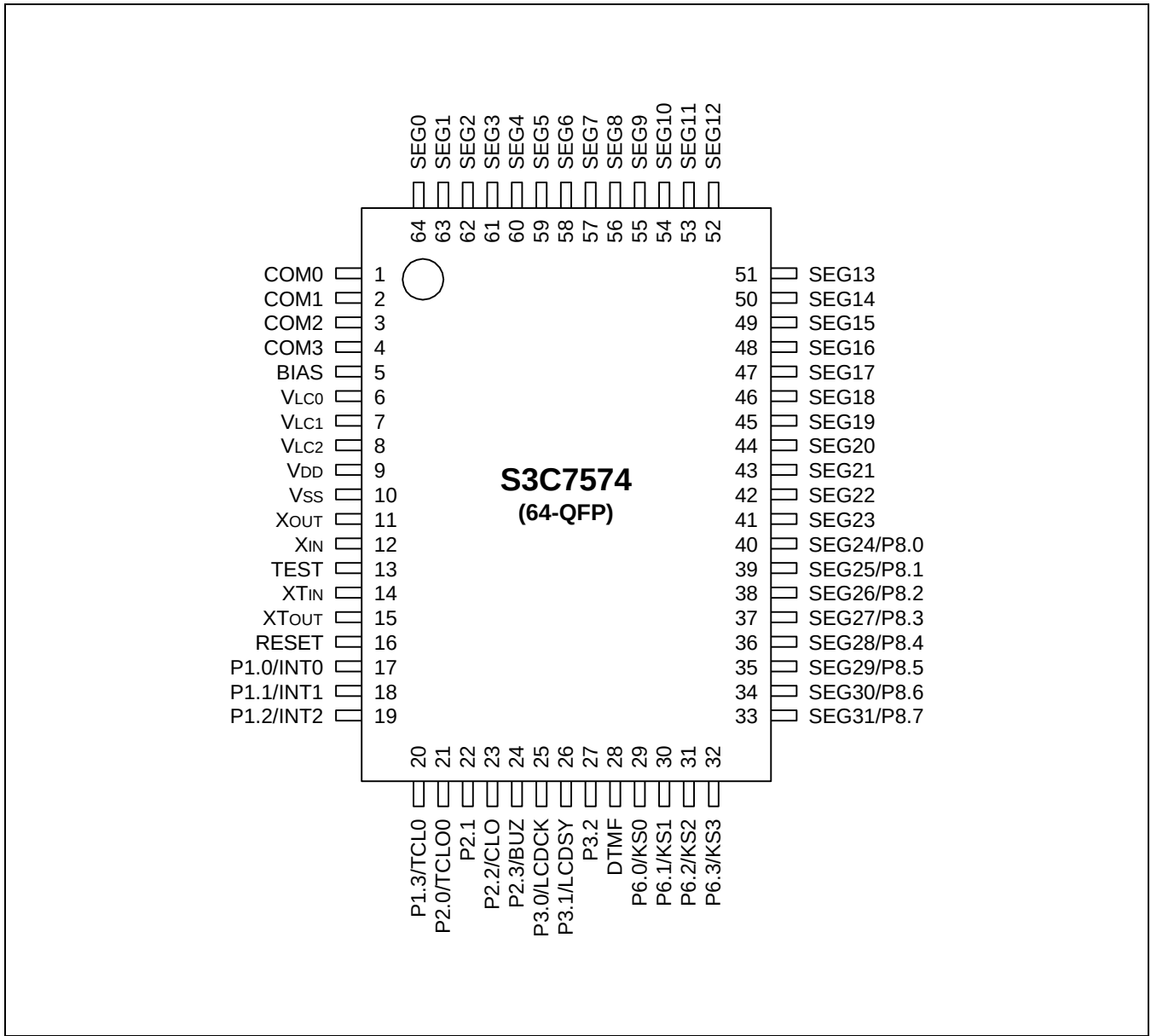


Figure 1-2. S3C7574 64-QFP Pin Assignment

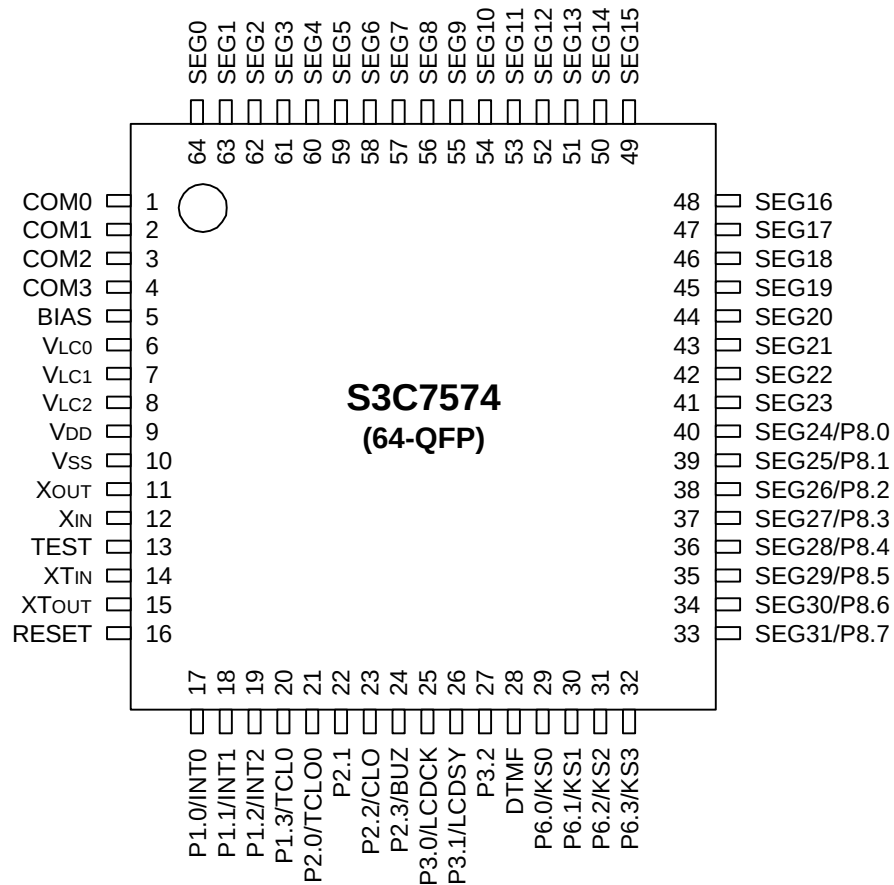


Figure 1-3. S3C7574 64-QFP Pin Assignment

## PIN DESCRIPTIONS

Table 1-1. S3C7574 Pin Descriptions

| Pin Name                           | Pin Type | Description                                                                                                                                                                        | Number               | Share Pin                    | Reset Value | Circuit Type |
|------------------------------------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|------------------------------|-------------|--------------|
| P1.0<br>P1.1<br>P1.2<br>P1.3       | I        | 4-bit input port.<br>1-bit or 4-bit read and test is possible.<br>4-bit pull-up resistors are software assignable.                                                                 | 17<br>18<br>19<br>20 | INT0<br>INT1<br>INT2<br>TCLO | Input       | A-4          |
| P2.0<br>P2.1<br>P2.2<br>P2.3       | I/O      | 4-bit I/O port.<br>1-bit and 4-bit read/write and test is possible.<br>4-bit pull-up resistors are software assignable.                                                            | 21<br>22<br>23<br>24 | TCLO0<br>–<br>CLO<br>BUZ     | Input       | D            |
| P3.0<br>P3.1<br>P3.2               | I/O      | 4-bit I/O port.<br>1-bit and 4-bit read/write and test is possible.<br>Each individual pin can be specified as input or output. 4-bit pull-up resistors are software assignable.   | 25<br>26<br>27       | LCDCK<br>LCDSY<br>–          | Input       | D            |
| P6.0–P6.3                          | I/O      | 4-bit I/O ports. Pins are individually software configurable as input or output. 1-bit and 4-bit read/write and test is possible. 4-bit pull-up resistors are software assignable. | 29–32                | KS0–KS3                      | Input       | D            |
| P8.0–P8.7                          | O        | Output port for 1-bit data (for use as CMOS driver only)                                                                                                                           | 33–40                | SEG24–SEG31                  | Output      | H-1          |
| DTMF                               | O        | DTMF output                                                                                                                                                                        | 28                   |                              | Output      | G-6          |
| SEG0–SEG23                         | O        | LCD segment signal output                                                                                                                                                          | 41–64                | –                            | Output      | H            |
| SEG24–SEG31                        | O        | LCD segment signal output                                                                                                                                                          | 33–40                | P8.0–P8.7                    | Output      | H-1          |
| COM0–COM3                          | O        | LCD common signal output                                                                                                                                                           | 1–4                  | –                            | Output      | H            |
| V <sub>LC0</sub> –V <sub>LC2</sub> | –        | LCD power supply.<br>Built-in voltage dividing resistors                                                                                                                           | 6–8                  | –                            | –           | –            |
| BIAS                               | –        | LCD power control                                                                                                                                                                  | 5                    | –                            | –           | –            |
| LCDCK                              | I/O      | LCD clock output for display expansion                                                                                                                                             | 25                   | P3.0                         | Input       | D            |

Table 1-1. S3P7574 Pin Descriptions (Continued)

| Pin Name                             | Pin Type | Description                                                                                                                                                                   | Number   | Share Pin    | Reset Value | Circuit Type |
|--------------------------------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|--------------|-------------|--------------|
| LCDSY                                | I/O      | LCD synchronization clock output for LCD display expansion                                                                                                                    | 26       | P3.1         | Input       | D            |
| TCL0                                 | I        | External clock input for timer/counter 0                                                                                                                                      | 20       | P1.3         | Input       | A-4          |
| TCLO0                                | I/O      | Timer/counter 0 clock output                                                                                                                                                  | 21       | P2.0         | Input       | D            |
| INT0<br>INT1                         | I        | External interrupt. The triggering edge for INT0 and INT1 is selectable. Only INT0 is synchronized with the system clock.                                                     | 17<br>18 | P1.0<br>P1.1 | Input       | A-4          |
| INT2                                 | I        | Quasi-interrupt with detection of rising edge signals.                                                                                                                        | 19       | P1.2         | Input       | A-4          |
| KS0–KS3                              | I/O      | Quasi-interrupt input with falling edge detection.                                                                                                                            | 29–32    | P6.0–P6.3    | Input       | D            |
| CLO                                  | I/O      | CPU clock output                                                                                                                                                              | 23       | P2.2         | Input       | D            |
| BUZ                                  | I/O      | 2, 4, 8 or 16 kHz frequency output for buzzer sound with 4.19 MHz main system clock or 32.768 kHz subsystem clock.                                                            | 24       | P2.3         | Input       | D            |
| X <sub>IN</sub> , X <sub>OUT</sub>   | –        | Crystal, ceramic or RC oscillator pins for main system clock. (For external clock input, use X <sub>IN</sub> and input X <sub>IN</sub> 's reverse phase to X <sub>OUT</sub> ) | 11, 12   | –            | –           | –            |
| XT <sub>IN</sub> , XT <sub>OUT</sub> | –        | Crystal oscillator pins for subsystem clock. (For external clock input, use XT <sub>IN</sub> and input XT <sub>IN</sub> 's reverse phase to XT <sub>OUT</sub> )               | 14, 15   | –            | –           | –            |
| V <sub>DD</sub>                      | –        | Main power supply                                                                                                                                                             | 9        | –            | –           | –            |
| V <sub>SS</sub>                      | –        | Ground                                                                                                                                                                        | 10       | –            | –           | –            |
| RESET                                | –        | Reset signal                                                                                                                                                                  | 16       | –            | Input       | B            |
| TEST                                 | –        | Test signal input (must be connected to V <sub>SS</sub> )                                                                                                                     | 13       | –            | –           | –            |

**NOTE:** Pull-up resistors for all I/O ports automatically disabled if they are configured to output mode.



PIN CIRCUIT

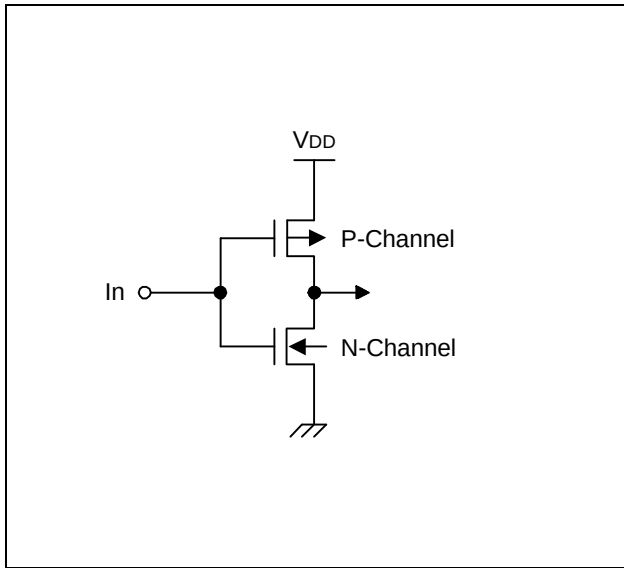


Figure 1-4. Pin Circuit Type A

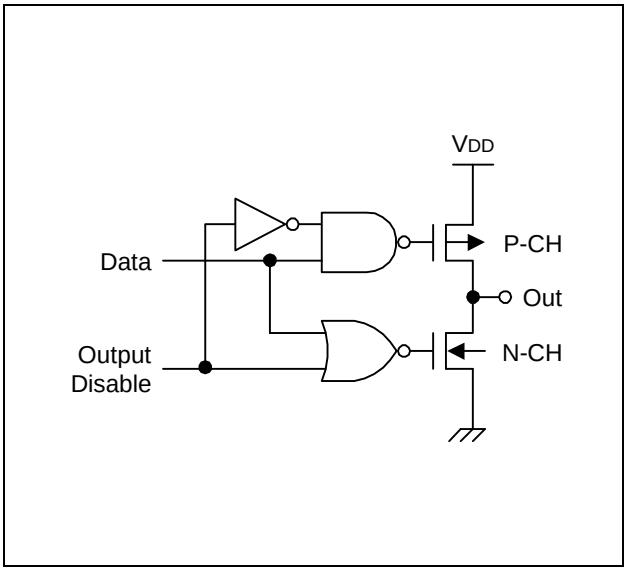


Figure 1-6. Pin Circuit Type C

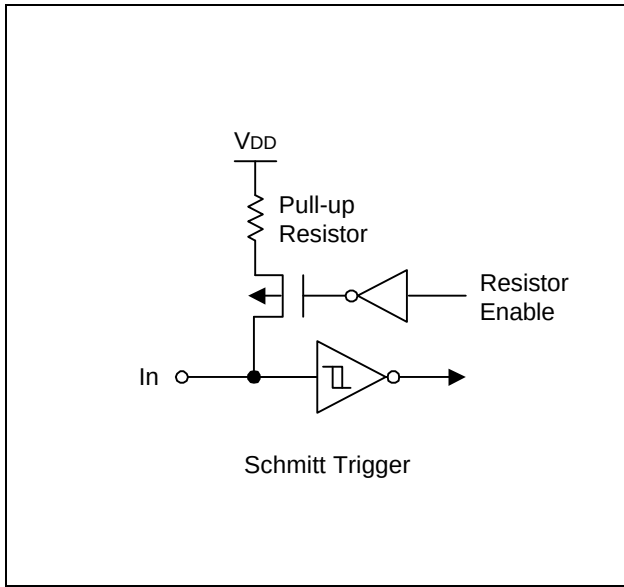


Figure 1-5. Pin Circuit Type A-4 (P1)

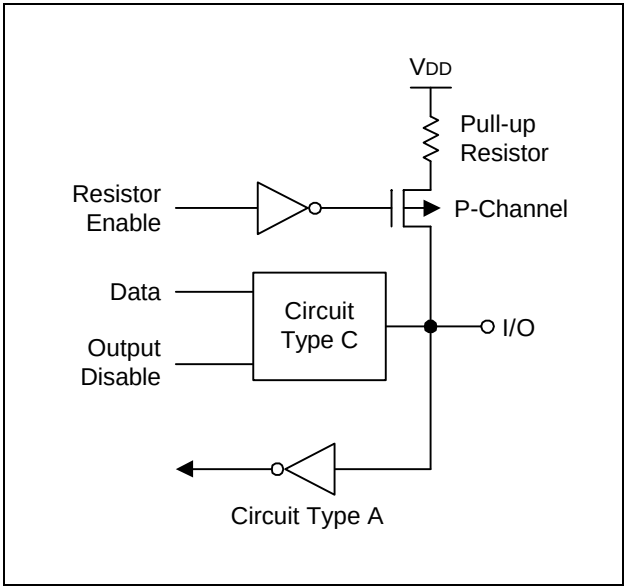


Figure 1-7. Pin Circuit Type D (P2, P3, and P6)

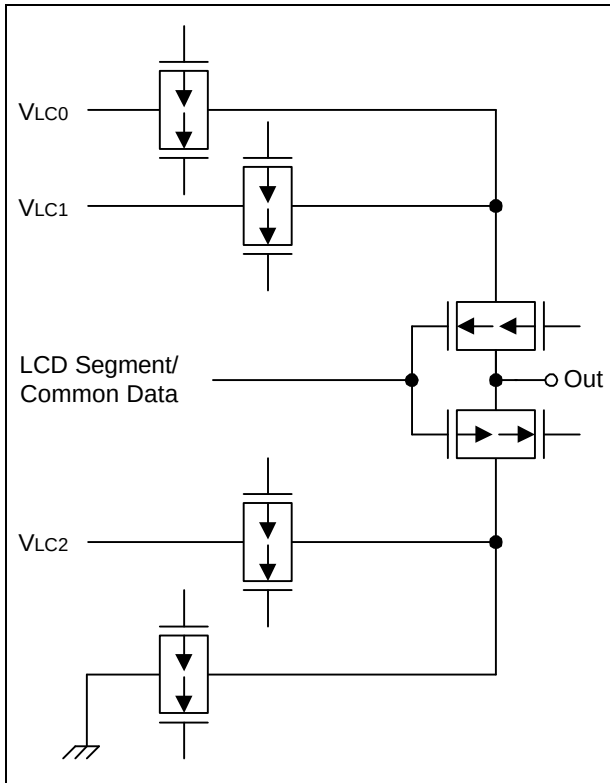


Figure 1-8. Pin Circuit Type H (SEG/COM)

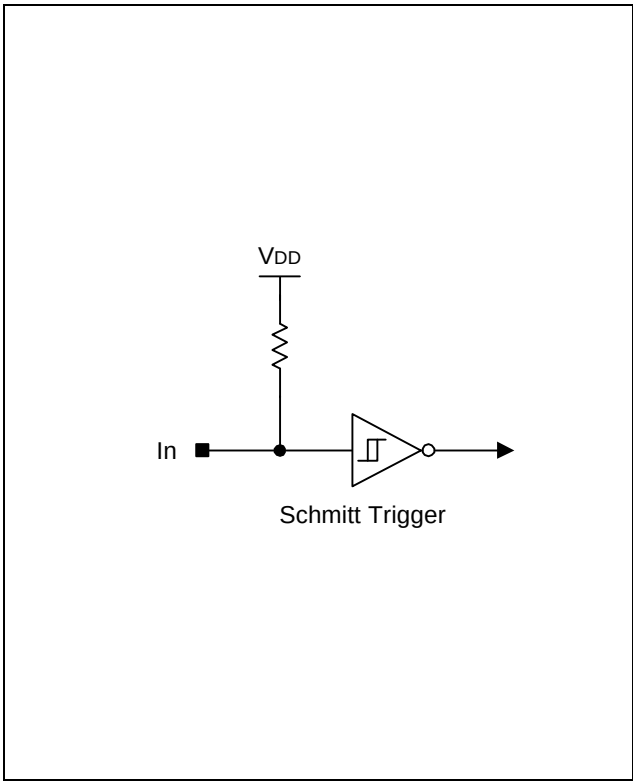


Figure 1-10. Pin Circuit Type B (RESET)

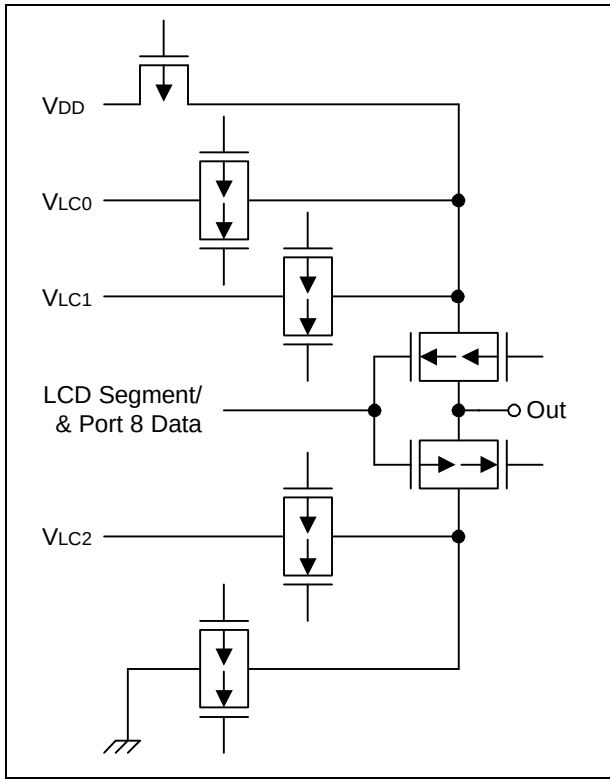


Figure 1-9. Pin Circuit Type H-1 (P8)

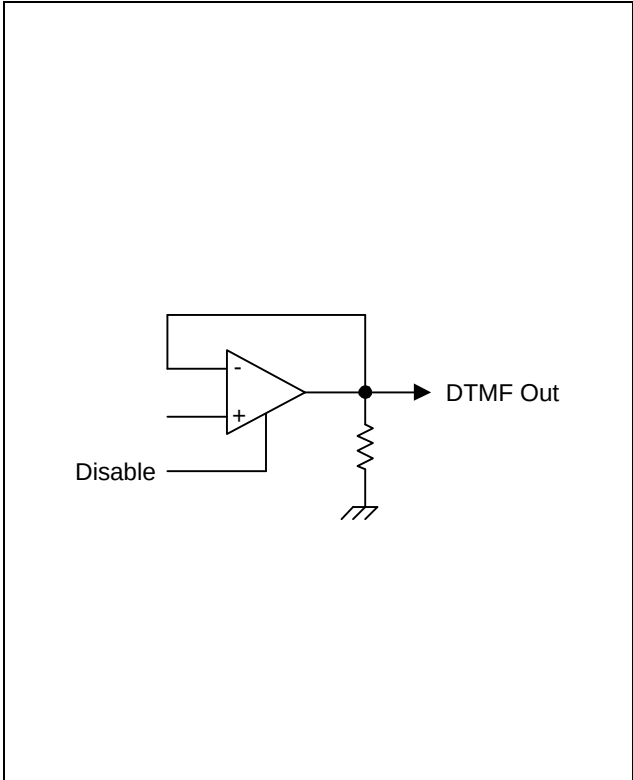


Figure 1-11. Pin Circuit Type G-6 (DTMF)

# 14

## ELECTRICAL DATA

### OVERVIEW

In this section, information on S3C7574 electrical characteristics is presented as tables and graphics. The information is arranged in the following order:

#### Standard Electrical Characteristics

- Absolute maximum ratings
- D.C. electrical characteristics
- Main system clock oscillator characteristics
- Subsystem clock oscillator characteristics
- I/O capacitance
- A.C. electrical characteristics
- Operating voltage range

#### Miscellaneous Timing Waveforms

- A.C timing measurement point
- Clock timing measurement at  $X_{IN}$
- Clock timing measurement at  $XT_{IN}$
- TCL0 timing
- Input timing for RESET
- Input timing for external interrupts

#### Stop Mode Characteristics and Timing Waveforms

- RAM data retention supply voltage in stop mode
- Stop mode release timing when initiated by RESET
- Stop mode release timing when initiated by an interrupt request

Table 14-1. Absolute Maximum Ratings

(T<sub>A</sub> = 25 °C)

| Parameter             | Symbol           | Conditions                    | Rating                         | Units |
|-----------------------|------------------|-------------------------------|--------------------------------|-------|
| Supply Voltage        | V <sub>DD</sub>  | —                             | – 0.3 to + 6.5                 | V     |
| Input Voltage         | V <sub>I1</sub>  | All I/O ports                 | – 0.3 to V <sub>DD</sub> + 0.3 |       |
| Output Voltage        | V <sub>O</sub>   |                               | – 0.3 to V <sub>DD</sub> + 0.3 |       |
| Output Current High   | I <sub>OH</sub>  | One I/O port active           | – 15                           | mA    |
|                       |                  | All I/O ports active          | – 30                           |       |
| Output Current Low    | I <sub>OL</sub>  | One I/O port active           | + 30 (Peak value)              |       |
|                       |                  |                               | + 15 (note)                    |       |
|                       |                  | Total value for ports 2 and 3 | + 60 (Peak value)              |       |
|                       |                  |                               | + 20 (note)                    |       |
|                       |                  | Total value for port 6        | + 50                           |       |
|                       |                  |                               | + 20 (note)                    |       |
| Operating Temperature | T <sub>A</sub>   | —                             | – 40 to + 85                   | °C    |
| Storage Temperature   | T <sub>stg</sub> | —                             | – 65 to + 150                  |       |

**NOTE:** The values for Output Current Low ( I<sub>OL</sub> ) are calculated as Peak Value × √Duty .

Table 14-2. D.C. Electrical Characteristics

(T<sub>A</sub> = – 40 °C to + 85 °C, V<sub>DD</sub> = 1.8 V to 5.5 V)

| Parameter           | Symbol           | Conditions                                                                             | Min                   | Typ | Max                 | Units |
|---------------------|------------------|----------------------------------------------------------------------------------------|-----------------------|-----|---------------------|-------|
| Input high voltage  | V <sub>IH1</sub> | All input pins except those specified below for V <sub>IH2</sub> , V <sub>IH3</sub>    | 0.7 V <sub>DD</sub>   | —   | V <sub>DD</sub>     | V     |
|                     | V <sub>IH2</sub> | Ports 1, 6, and RESET                                                                  | 0.8 V <sub>DD</sub>   | —   | V <sub>DD</sub>     |       |
|                     | V <sub>IH3</sub> | X <sub>IN</sub> , X <sub>OUT</sub> , and XT <sub>IN</sub>                              | V <sub>DD</sub> – 0.1 | —   | V <sub>DD</sub>     |       |
| Input low voltage   | V <sub>IL1</sub> | Ports 2 and 3                                                                          | —                     | —   | 0.3 V <sub>DD</sub> | V     |
|                     | V <sub>IL2</sub> | Ports 1, 6 and RESET                                                                   | —                     | —   | 0.2 V <sub>DD</sub> |       |
|                     | V <sub>IL3</sub> | X <sub>IN</sub> , X <sub>OUT</sub> , and XT <sub>IN</sub>                              | —                     | —   | 0.1                 |       |
| Output high voltage | V <sub>OH1</sub> | V <sub>DD</sub> = 4.5 V to 5.5 V<br>I <sub>OH</sub> = – 1 mA<br>Ports 2, 3, 6 and BIAS | V <sub>DD</sub> – 1.0 | —   | —                   | V     |
|                     | V <sub>OH2</sub> | V <sub>DD</sub> = 4.5 V to 5.5 V<br>I <sub>OH</sub> = –100 μA Port 8 only              | V <sub>DD</sub> – 2.0 | —   | —                   |       |

Table 14-2. D.C. Electrical Characteristics (Continued)

(T<sub>A</sub> = -40 °C to +85 °C, V<sub>DD</sub> = 1.8 V to 5.5 V)

| Parameter                     | Symbol            | Conditions                                                                                               | Min | Typ  | Max  | Units |
|-------------------------------|-------------------|----------------------------------------------------------------------------------------------------------|-----|------|------|-------|
| Output low voltage            | V <sub>OL1</sub>  | V <sub>DD</sub> = 4.5 V to 5.5 V<br>I <sub>OL</sub> = 15 mA, Ports 2, 3, 6                               | —   | 0.4  | 2    | V     |
|                               | V <sub>OL2</sub>  | V <sub>DD</sub> = 4.5 V to 5.5 V<br>I <sub>OL</sub> = 100 µA; Port 8 only                                | —   | —    | 1    |       |
| Input high leakage current    | I <sub>LIH1</sub> | V <sub>IN</sub> = V <sub>DD</sub><br>All input pins except those specified below for I <sub>LIH2</sub>   | —   | —    | 3    | µA    |
|                               | I <sub>LIH2</sub> | V <sub>IN</sub> = V <sub>DD</sub><br>X <sub>IN</sub> , X <sub>OUT</sub> and XT <sub>IN</sub>             |     |      | 20   |       |
| Input low leakage current     | I <sub>LIL1</sub> | V <sub>IN</sub> = 0 V<br>All input pins except X <sub>IN</sub> , X <sub>OUT</sub> , and XT <sub>IN</sub> | —   | —    | -3   |       |
|                               | I <sub>LIL2</sub> | V <sub>IN</sub> = 0 V<br>X <sub>IN</sub> , X <sub>OUT</sub> , and XT <sub>IN</sub>                       |     |      | -20  |       |
| Output high leakage current   | I <sub>LOH1</sub> | V <sub>OUT</sub> = V <sub>DD</sub><br>All output pins                                                    | —   | —    | 3    | µA    |
| Output low leakage current    | I <sub>LOL</sub>  | V <sub>OUT</sub> = 0 V<br>All output pins                                                                |     |      | -3   |       |
| Pull-up resistor              | R <sub>L1</sub>   | V <sub>IN</sub> = 0 V; V <sub>DD</sub> = 5 V<br>Ports 1, 2, 3, 6                                         | 25  | 50   | 100  | KΩ    |
|                               |                   | V <sub>DD</sub> = 3 V                                                                                    | 50  | 100  | 200  |       |
|                               | R <sub>L2</sub>   | V <sub>IN</sub> = 0 V; V <sub>DD</sub> = 5 V<br>RESET                                                    | 100 | 250  | 400  |       |
|                               |                   | V <sub>DD</sub> = 3 V                                                                                    | 200 | 500  | 800  |       |
| LCD voltage dividing resistor | R <sub>LCD</sub>  | T <sub>A</sub> = 25 °C                                                                                   | 100 | 150  | 200  |       |
| COM output impedance          | R <sub>COM</sub>  | V <sub>DD</sub> = 5 V                                                                                    | —   | 3    | 6    |       |
|                               |                   | V <sub>DD</sub> = 3 V                                                                                    |     | 5    | 15   |       |
| SEG output impedance          | R <sub>SEG</sub>  | V <sub>DD</sub> = 5 V                                                                                    |     | 3    | 6    |       |
|                               |                   | V <sub>DD</sub> = 3 V                                                                                    |     | 5    | 15   |       |
| COM output voltage deviation  | V <sub>DC</sub>   | V <sub>DD</sub> = 5 V (V <sub>LC0</sub> -COM <sub>i</sub> )<br>I <sub>O</sub> = ± µA (I = 0-3)           | —   | ± 45 | ± 90 | mV    |

Table 14-2. D.C. Electrical Characteristics (Continued)

(T<sub>A</sub> = -40 °C to +85 °C, V<sub>DD</sub> = 1.8 V to 5.5 V)

| Parameter                       | Symbol           | Conditions                                                                                       | Min                          | Typ                 | Max                          | Units |
|---------------------------------|------------------|--------------------------------------------------------------------------------------------------|------------------------------|---------------------|------------------------------|-------|
| SEG output voltage deviation    | V <sub>DS</sub>  | V <sub>DD</sub> = 5 V (V <sub>LC0</sub> -EG <sub>i</sub> )<br>I <sub>O</sub> = ± 15 uA (i = 031) | -                            | ± 45                | ± 90                         | mV    |
| V <sub>LC0</sub> Output voltage | V <sub>LC0</sub> | T <sub>A</sub> = 25 °C                                                                           | 0.6 V <sub>DD</sub><br>- 0.2 | 0.6 V <sub>DD</sub> | 0.6 V <sub>DD</sub><br>+ 0.2 | V     |
| V <sub>LC1</sub> Output voltage | V <sub>LC1</sub> | T <sub>A</sub> = 25 °C                                                                           | 0.4 V <sub>DD</sub><br>- 0.2 | 0.4 V <sub>DD</sub> | 0.4 V <sub>DD</sub><br>+ 0.2 |       |
| V <sub>LC2</sub> Output voltage | V <sub>LC2</sub> | T <sub>A</sub> = 25 °C                                                                           | 0.2 V <sub>DD</sub><br>- 0.2 | 0.2 V <sub>DD</sub> | 0.2 V <sub>DD</sub><br>+ 0.2 |       |

Table 14-2. D.C. Electrical Characteristics (Continued)

(T<sub>A</sub> = -40 °C to +85 °C, V<sub>DD</sub> = 1.8 V to 5.5 V)

| Parameter             | Symbol                                        | Conditions                                                                                                                            |                                                     | Min | Typ        | Max        | Units |
|-----------------------|-----------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------|-----|------------|------------|-------|
| Supply Current<br>(1) | I <sub>DD1</sub> <sup>(2)</sup><br>(DTMF On)  | Main operating:<br>V <sub>DD</sub> = 5 V ± 10 %<br>CPU = f <sub>x</sub> /4<br>SCMOD = 0000B<br>Crystal oscillator<br>C1 = C2 = 22 pF  | 3.58 MHz                                            | —   | 3.9        | 7.0        | mA    |
|                       |                                               | V <sub>DD</sub> = 3 V ± 10 %                                                                                                          |                                                     |     | 2.0        | 4.0        |       |
|                       | I <sub>DD2</sub> <sup>(2)</sup><br>(DTMF Off) | Main idle mode;<br>V <sub>DD</sub> = 5 V ± 10 %<br>CPU = f <sub>x</sub> /4<br>SCMOD = 0000B<br>Crystal oscillator<br>C1 = C2 = 22 pF  | 6.0 MHz<br>3.58 MHz                                 | —   | 3.5<br>2.5 | 8.0<br>5.0 |       |
|                       |                                               | V <sub>DD</sub> = 3 V ± 10 %                                                                                                          | 6.0 MHz<br>3.58 MHz                                 |     | 1.6<br>1.2 | 4.0<br>2.3 |       |
|                       | I <sub>DD3</sub> <sup>(2)</sup>               | Main operating:<br>V <sub>DD</sub> = 5 V ± 10 %<br>CPU = f <sub>x</sub> /4,<br>SCMOD = 0000B<br>Crystal oscillator<br>C1 = C2 = 22 pF | 6.0 MHz<br>3.58 MHz                                 | —   | 1.0<br>0.9 | 2.5<br>1.8 | μA    |
|                       |                                               | V <sub>DD</sub> = 3 V ± 10 %                                                                                                          | 6.0 MHz<br>3.58 MHz                                 |     | 0.5<br>0.4 | 1.0<br>0.8 |       |
|                       | I <sub>DD4</sub>                              | Sub operating:<br>V <sub>DD</sub> = 3 V ± 10 %<br>CPU = f <sub>xt</sub> /4,<br>SCMOD = 1001B<br>32 kHz crystal oscillator             |                                                     | —   | 15         | 30         |       |
|                       | I <sub>DD5</sub>                              | Sub idle mode:<br>V <sub>DD</sub> = 3 V ± 10 %<br>CPU = f <sub>xt</sub> /4, SCMOD = 1001B<br>32 kHz crystal oscillator                |                                                     | —   | 6          | 15         |       |
|                       | I <sub>DD6</sub>                              | Stop mode;<br>V <sub>DD</sub> = 5 V ± 10 %<br>V <sub>DD</sub> = 3 V ± 10 %                                                            | SCMOD = 0000B<br>X <sub>T</sub> <sub>IN</sub> = 0 V | —   | 2.0<br>0.6 | 5<br>3     |       |
|                       |                                               | Stop mode;<br>V <sub>DD</sub> = 5 V ± 10 %<br>V <sub>DD</sub> = 3 V ± 10 %                                                            | SCMOD = 0100B                                       |     | 0.2<br>0.1 | 3<br>2     |       |

Table 14-2. D.C. Electrical Characteristics (Continued)

(T<sub>A</sub> = - 40 °C to + 85 °C, V<sub>DD</sub> = 1.8 V to 5.5 V)

| Parameter                   | Symbol           | Conditions                                                                                   | Min    | Typ   | Max   | Units |
|-----------------------------|------------------|----------------------------------------------------------------------------------------------|--------|-------|-------|-------|
| Row Tone Level              | V <sub>ROW</sub> | V <sub>DD</sub> = 2.0 to 5.5 V<br>RL = 12 kΩ; Temp = - 30 to 60 °C                           | - 16.0 | -14.0 | -12.0 | dBV   |
| Ratio of Column to Row tone | dB <sub>CR</sub> | V <sub>DD</sub> = 2.0 to 5.5 V<br>RL = 12 kΩ; Temp = - 30 to 60 °C                           | 1      | 2     | 3     | dB    |
| Distortion (Dual tone)      | THD              | V <sub>DD</sub> = 2.0 to 5.5 V<br>1 MHz band<br>R <sub>L</sub> = 12 kΩ; Temp = - 30 to 60 °C | —      | —     | 5     | %     |

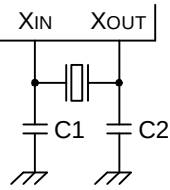
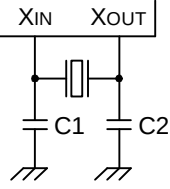
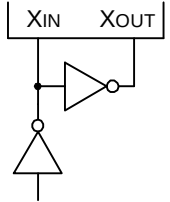
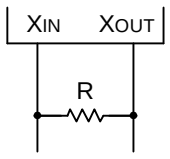
**NOTES:**

1. D.C. electrical values for supply current (I<sub>DD1</sub> to I<sub>DD7</sub>) do not include current drawn through internal pull-up resistors and through LCD voltage dividing resistors.
2. Data includes the power consumption for sub-system clock oscillation.
3. When the system clock mode register, SCMOD, is set to 0100B, the sub-system clock oscillation stops. The main-system clock oscillation stops by the STOP instruction.



Table 14-3. Main System Clock Oscillator Characteristics

(T<sub>A</sub> = -40 °C + 85 °C, V<sub>DD</sub> = 1.8 V to 5.5 V)

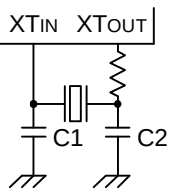
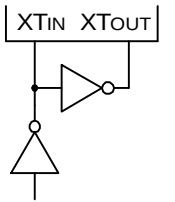
| Oscillator         | Clock Configuration                                                                 | Parameter                                                                           | Test Condition                                                                                | Min  | Typ             | Max | Units |
|--------------------|-------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------|------|-----------------|-----|-------|
| Ceramic Oscillator |    | Oscillation frequency (1)                                                           | —                                                                                             | 0.4  | —               | 6.0 | MHz   |
|                    |                                                                                     | Stabilization time (2)                                                              | Stabilization occurs when V <sub>DD</sub> is equal to the minimum oscillator voltage range.   | —    | —               | 4   | ms    |
| Crystal Oscillator |   | Oscillation frequency (1)                                                           | —                                                                                             | 0.4  | —               | 6.0 | MHz   |
|                    |                                                                                     | Stabilization time (2)                                                              | V <sub>DD</sub> = 4.5 V to 5.5 V                                                              | —    | —               | 10  | ms    |
|                    |                                                                                     |                                                                                     | V <sub>DD</sub> = 1.8 V to 4.5 V                                                              | —    | —               | 30  |       |
| External Clock     |  | X <sub>IN</sub> input frequency (1)                                                 | —                                                                                             | 0.4  | —               | 6.0 | MHz   |
|                    |                                                                                     | X <sub>IN</sub> input high and low level width (t <sub>XH</sub> , t <sub>XL</sub> ) | —                                                                                             | 83.3 | —               | —   | ns    |
| RC Oscillator      |  | Frequency (1)                                                                       | V <sub>DD</sub> = 5 V<br>R = 20 KΩ, V <sub>DD</sub> = 5 V<br>R = 39 KΩ, V <sub>DD</sub> = 3 V | 0.4  | —<br>2.0<br>1.0 | 2   | MHz   |

**NOTES:**

- Oscillation frequency and X<sub>IN</sub> input frequency data are for oscillator characteristics only.
- Stabilization time is the interval required for oscillator stabilization after a power-on occurs, or when stop mode is terminated.

Table 14-4. Subsystem Clock Oscillator Characteristics

(T<sub>A</sub> = -40 °C + 85 °C, V<sub>DD</sub> = 1.8 V to 5.5 V)

| Oscillator         | Clock Configuration                                                               | Parameter                                                                              | Test Condition                   | Min | Typ    | Max | Units |
|--------------------|-----------------------------------------------------------------------------------|----------------------------------------------------------------------------------------|----------------------------------|-----|--------|-----|-------|
| Crystal Oscillator |  | Oscillation frequency (1)                                                              | —                                | 32  | 32.768 | 35  | kHz   |
|                    |                                                                                   | Stabilization time (2)                                                                 | V <sub>DD</sub> = 4.5 V to 5.5 V | —   | 1.0    | 2   | s     |
|                    |                                                                                   |                                                                                        | V <sub>DD</sub> = 1.8 V to 4.5 V | —   | —      | 10  |       |
| External Clock     |  | XT <sub>IN</sub> input frequency (1)                                                   | —                                | 32  | —      | 100 | kHz   |
|                    |                                                                                   | XT <sub>IN</sub> input high and low level width (t <sub>XTL</sub> , t <sub>XTH</sub> ) | —                                | 5   | —      | 15  | μs    |

**NOTES:**

1. Oscillation frequency and XT<sub>IN</sub> input frequency data are for oscillator characteristics only.
2. Stabilization time is the interval required for oscillator stabilization after a power-on occurs.

Table 14-5. Input/output Capacitance

(T<sub>A</sub> = 25 °C, V<sub>DD</sub> = 0 V)

| Parameter          | Symbol           | Condition                                                  | Min | Typ | Max | Units |
|--------------------|------------------|------------------------------------------------------------|-----|-----|-----|-------|
| Input capacitance  | C <sub>IN</sub>  | f = 1 MHz; Unmeasured pins are returned to V <sub>SS</sub> | –   | –   | 15  | pF    |
| Output capacitance | C <sub>OUT</sub> |                                                            | –   | –   | 15  | pF    |
| I/O capacitance    | C <sub>IO</sub>  |                                                            | –   | –   | 15  | pF    |

Table 14-6. A.C. Electrical Characteristics

(T<sub>A</sub> = –40 °C to +85 °C, V<sub>DD</sub> = 1.8 V to 5.5 V)

| Parameter                       | Symbol                                | Conditions                       | Min  | Typ | Max | Units |
|---------------------------------|---------------------------------------|----------------------------------|------|-----|-----|-------|
| Instruction cycle time (1)      | t <sub>CY</sub>                       | V <sub>DD</sub> = 2.7 V to 5.5 V | 0.67 | –   | 64  | μs    |
|                                 |                                       | V <sub>DD</sub> = 1.8 V to 5.5 V | 0.95 | –   | 64  |       |
|                                 |                                       | With subsystem clock (fxt)       | 114  | 122 | 125 |       |
| TCL0 input frequency            | f <sub>TIO</sub>                      | V <sub>DD</sub> = 2.7 V to 5.5 V | 0    | –   | 1.5 | MHz   |
|                                 |                                       | V <sub>DD</sub> = 1.8 V to 5.5 V |      |     | 1   | MHz   |
| TCL0 input high, low width      | t <sub>TIH0</sub> , t <sub>TIL0</sub> | V <sub>DD</sub> = 2.7 V to 5.5 V | 0.48 | –   | –   | μs    |
|                                 |                                       | V <sub>DD</sub> = 1.8 V to 5.5 V | 1.8  |     |     |       |
| Interrupt input high, low width | t <sub>INTH</sub> , t <sub>INTL</sub> | INT0                             | (2)  | –   | –   | μs    |
|                                 |                                       | INT1, INT2, KS0–KS3              | 10   |     |     |       |
| RESET Input Low Width           | t <sub>RSL</sub>                      | Input                            | 10   | –   | –   | μs    |

**NOTES:**

1. Unless otherwise specified, Instruction Cycle Time condition values assume a main system clock (fx) source.
2. Minimum value for INT0 is based on a clock of 2t<sub>CY</sub> or 128/fx as assigned by the IMOD0 register setting.

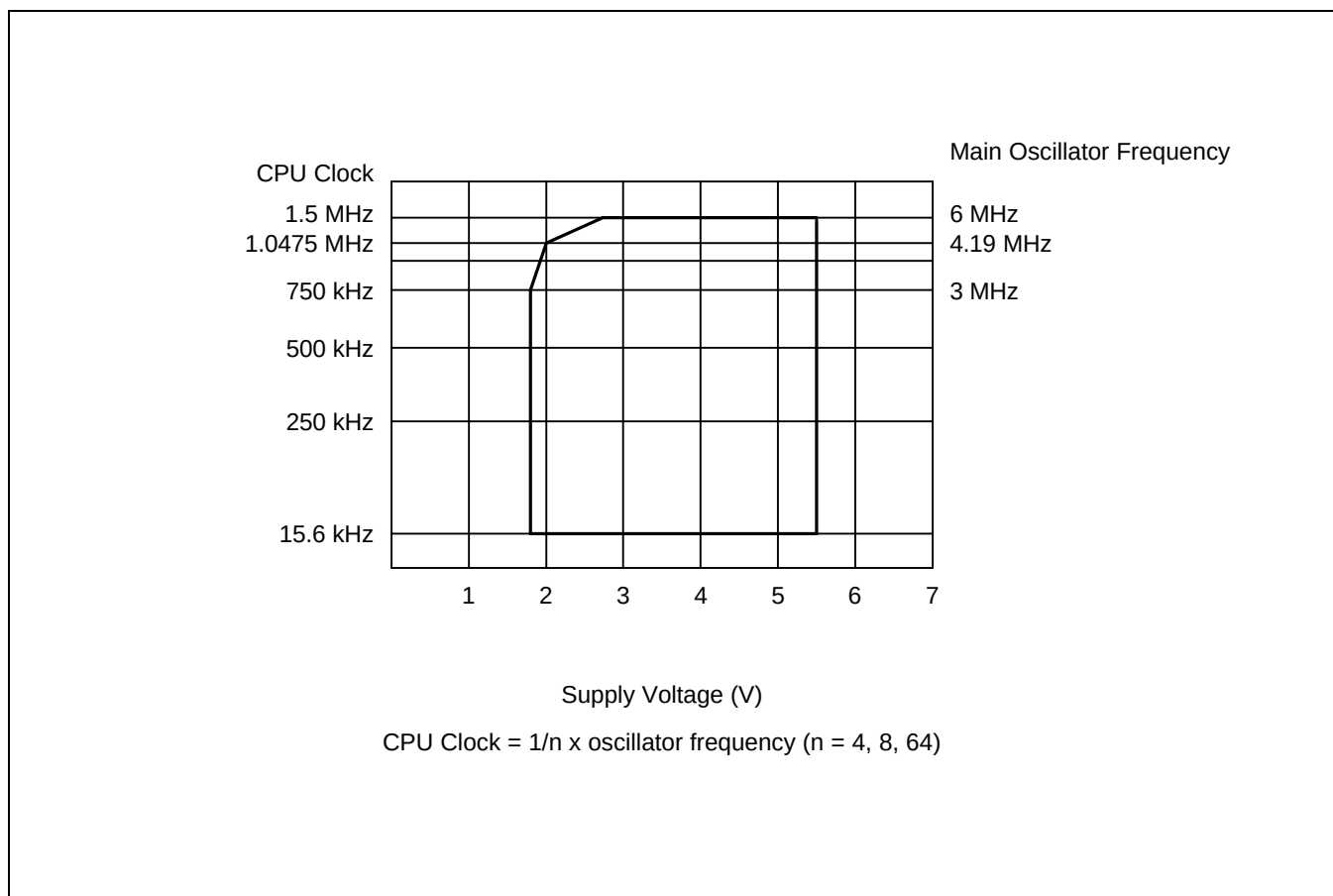


Figure 14-1. Standard Operating Voltage Range

Table 14-7. RAM Data Retention Supply Voltage in Stop Mode

(T<sub>A</sub> = -40 °C to +85 °C)

| Parameter                              | Symbol            | Conditions                | Min | Typ                 | Max | Unit |
|----------------------------------------|-------------------|---------------------------|-----|---------------------|-----|------|
| Data retention supply voltage          | V <sub>DDDR</sub> | Normal operation          | 1.5 | —                   | 6.5 | V    |
| Data retention supply current          | I <sub>DDDR</sub> | V <sub>DDDR</sub> = 2.0 V | —   | 0.1                 | 1   | μA   |
| Release signal set time                | t <sub>SREL</sub> | Normal operation          | 0   | —                   | —   | μs   |
| Oscillator stabilization wait time (1) | t <sub>WAIT</sub> | Released by RESET         | —   | 2 <sup>17</sup> /fx | —   | ms   |
|                                        |                   | Released by interrupt     | —   | (2)                 | —   |      |

**NOTES:**

- During oscillator stabilization wait time, all CPU operations must be stopped to avoid instability during oscillator start-up.
- Use the basic timer mode register (BMOD) interval timer to delay execution of CPU instructions during the wait time.

## TIMING WAVEFORMS

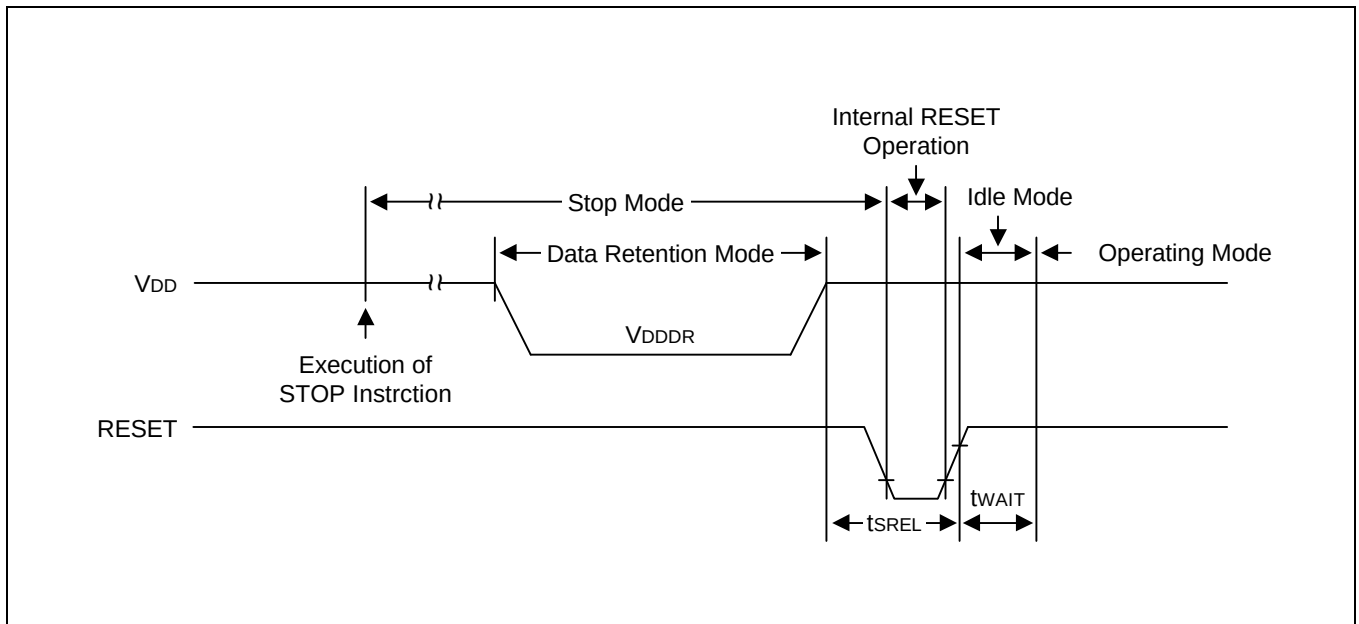


Figure 14-2. Stop Mode Release Timing When Initiated by RESET

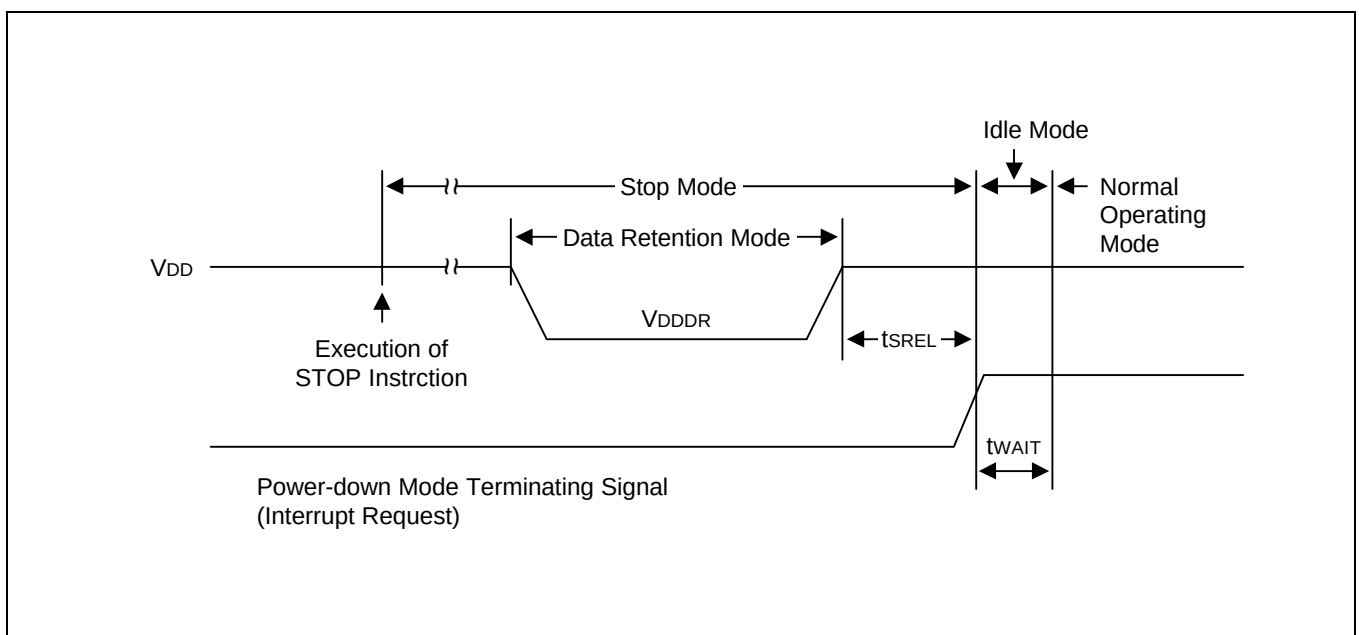


Figure 14-3. Stop Mode Release Timing When Initiated by Interrupt Request

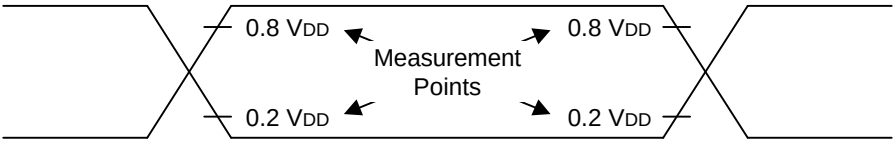


Figure 14-4. A.C. Timing Measurement Points (Except for X<sub>IN</sub> and XT<sub>IN</sub>)

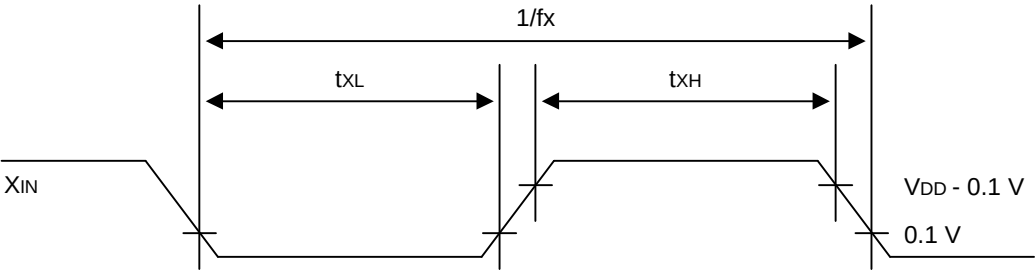


Figure 14-5. Clock Timing Measurement at X<sub>IN</sub>

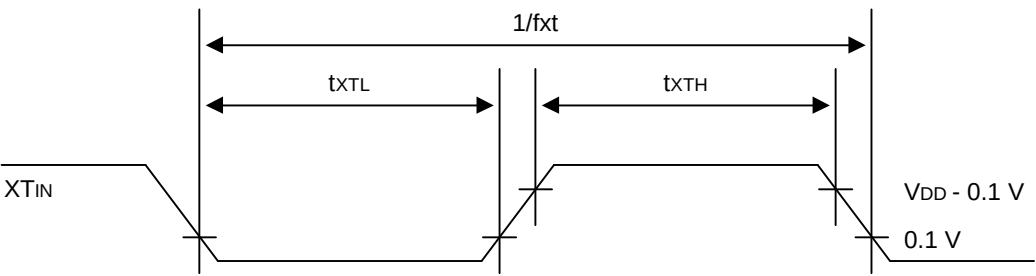


Figure 14-6. Clock Timing Measurement at XT<sub>IN</sub>

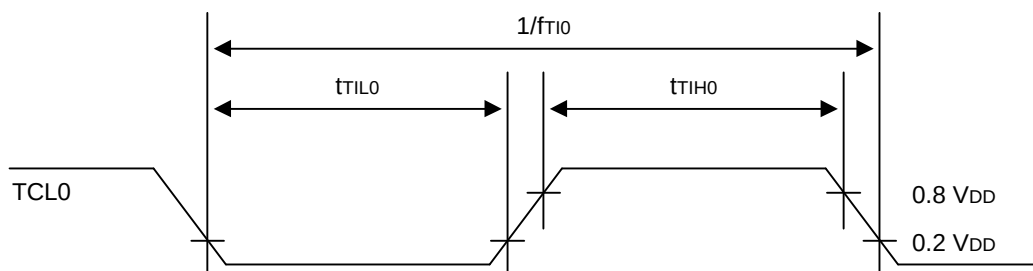


Figure 14-7. TCL0 Timing

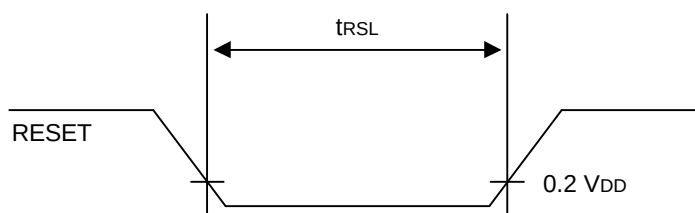


Figure 14-8. Input Timing for RESET Signal

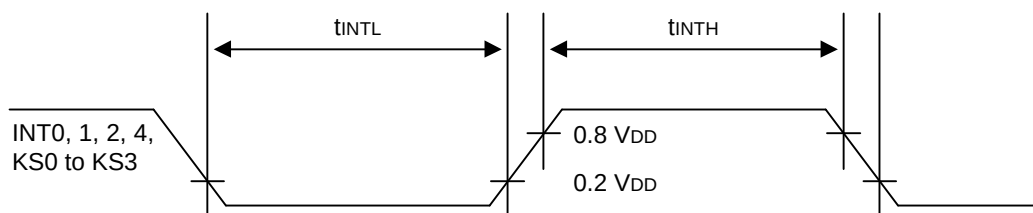


Figure 14-9. Input Timing for External Interrupts and Quasi-Interrupts

# 15

## MECHANICAL DATA

### OVERVIEW

The S3C7574 microcontroller is available in a 64-pin QFP package (Samsung: 64-QFP-1420F and 64-QFP-1414). Package dimensions are shown in Figure 15-1 and Figure 15-2.

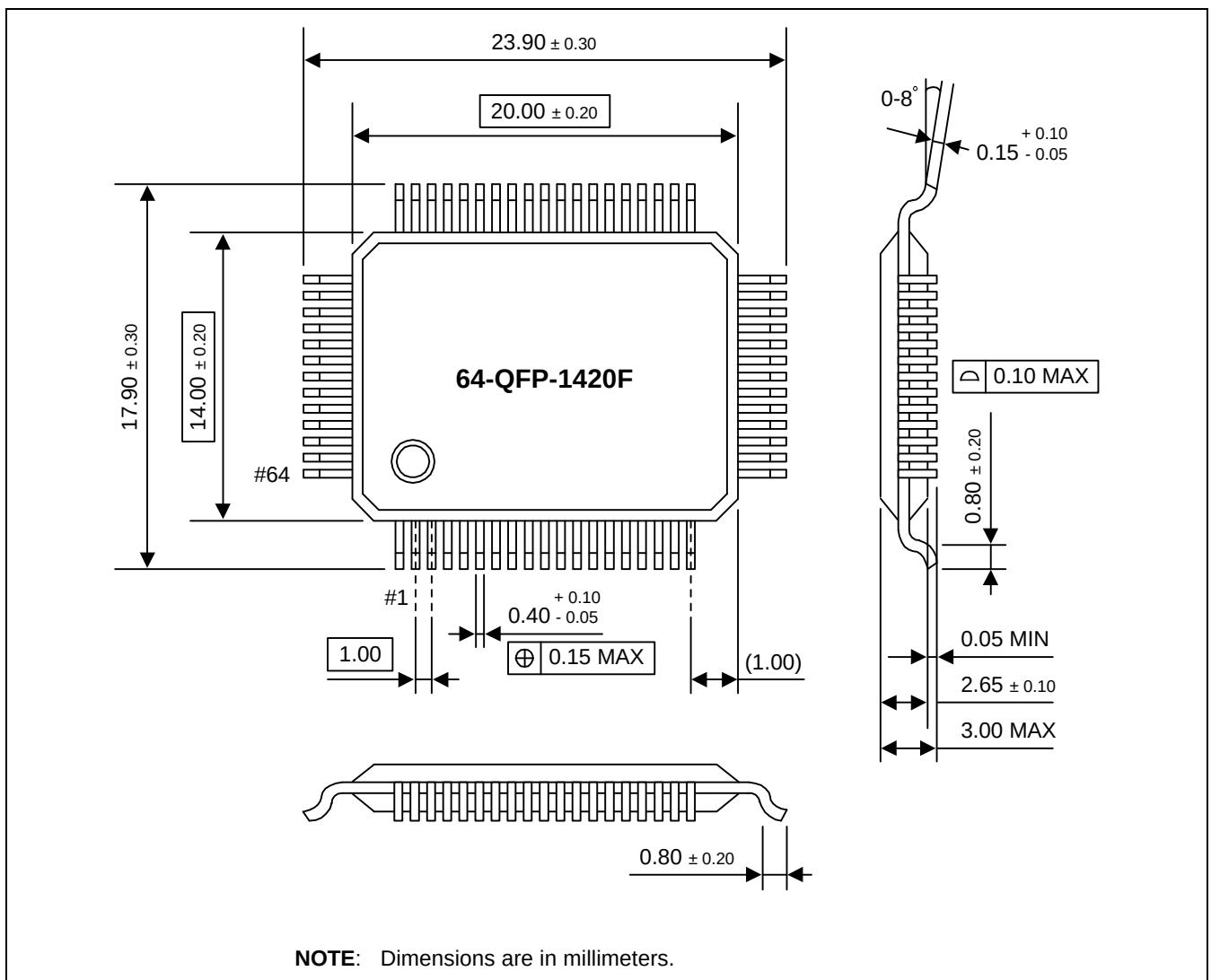
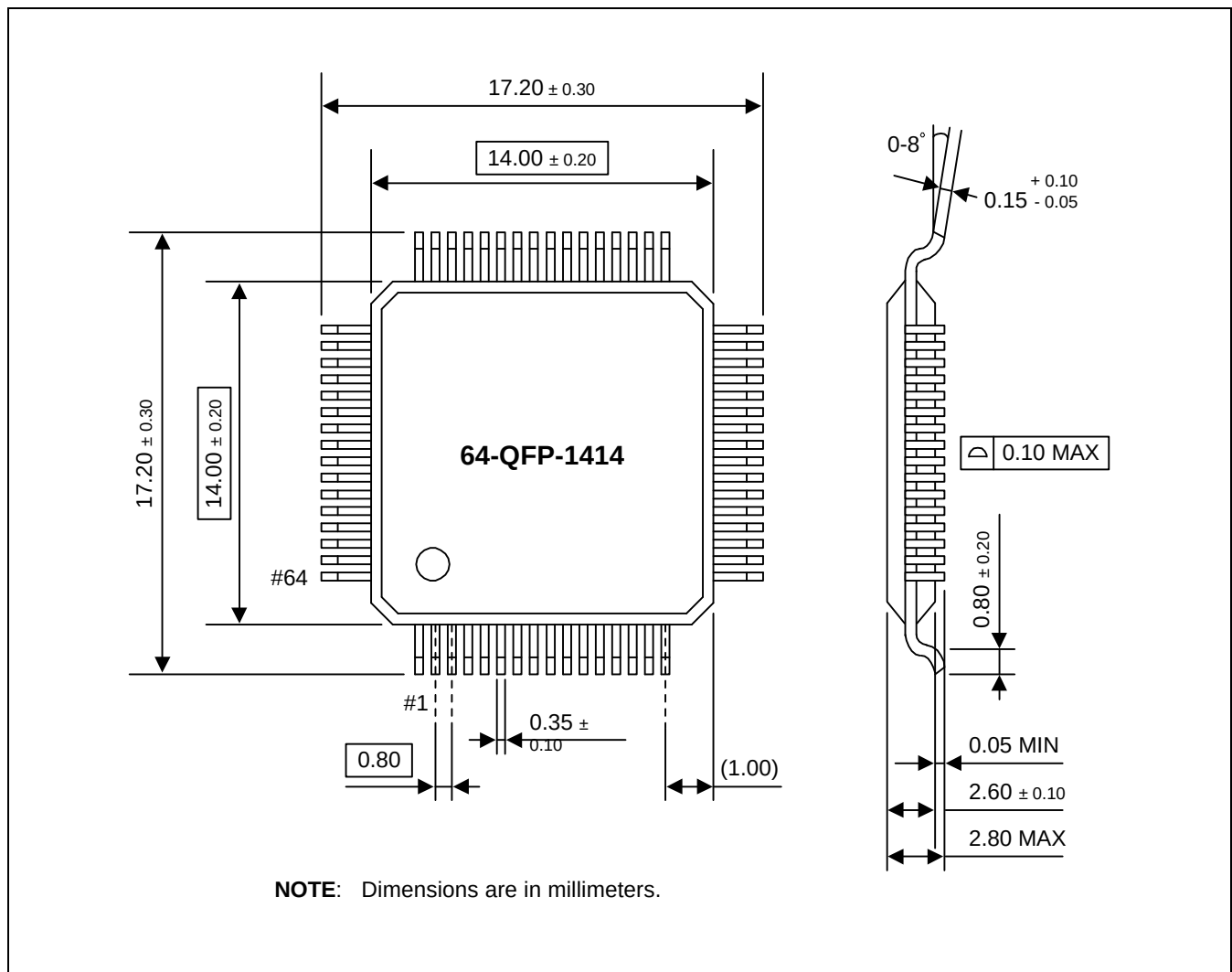


Figure 15-1. 64-QFP-1420F Package Dimensions





# 16

## S3P7574 OTP

### OVERVIEW

The S3P7574 single-chip CMOS microcontroller is the OTP (One Time Programmable) version of the S3C7574 microcontroller. It has an on-chip EPROM instead of masked ROM. The EPROM is accessed by a serial data format.

The S3P7574 is fully compatible with the S3C7574, both in function and in pin configuration. Because of its simple programming requirements, the S3P7574 is ideal for use as an evaluation chip for the S3C7574.

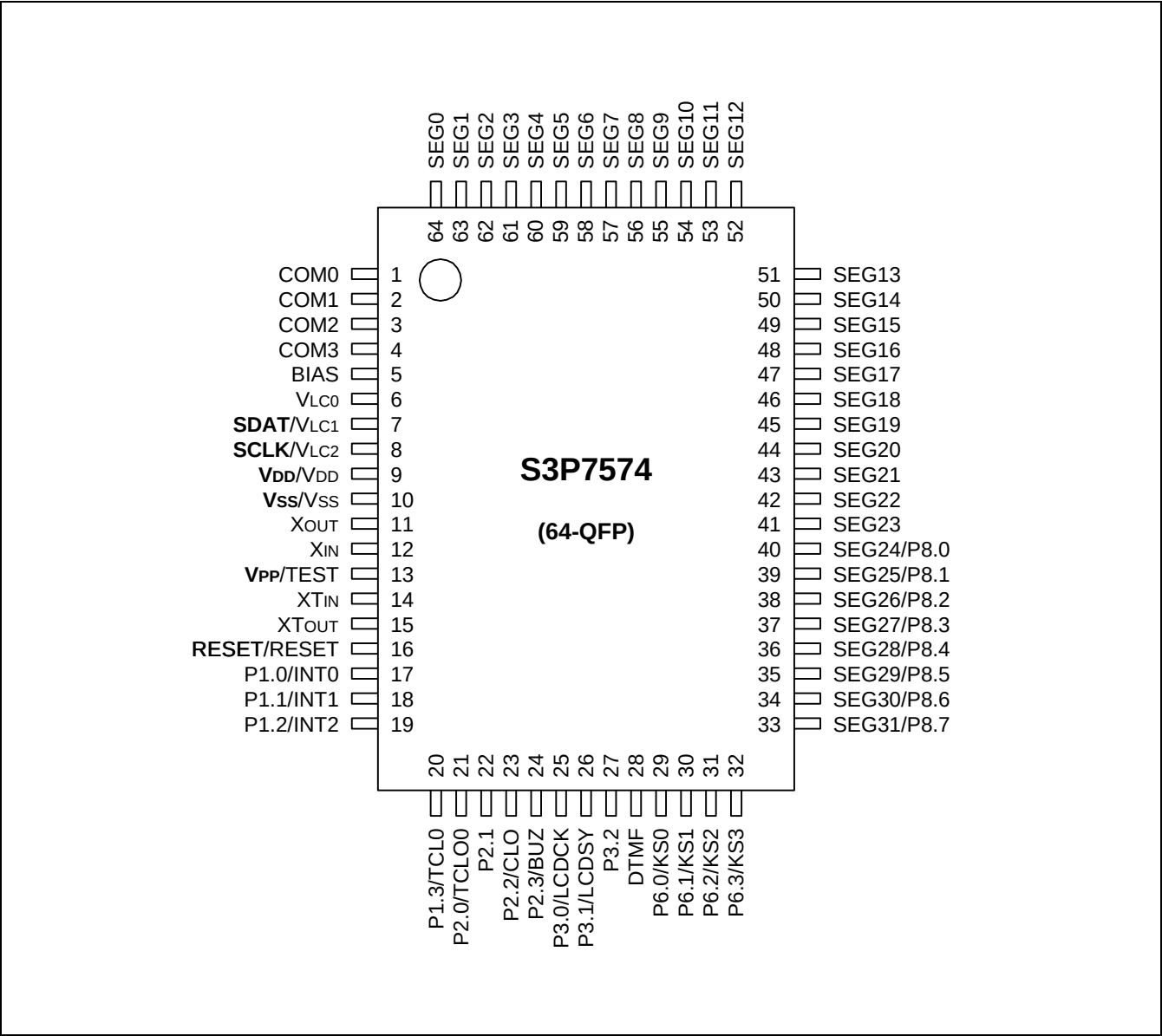


Figure 16-1. S3P7574 Pin Assignments (64-QFP)

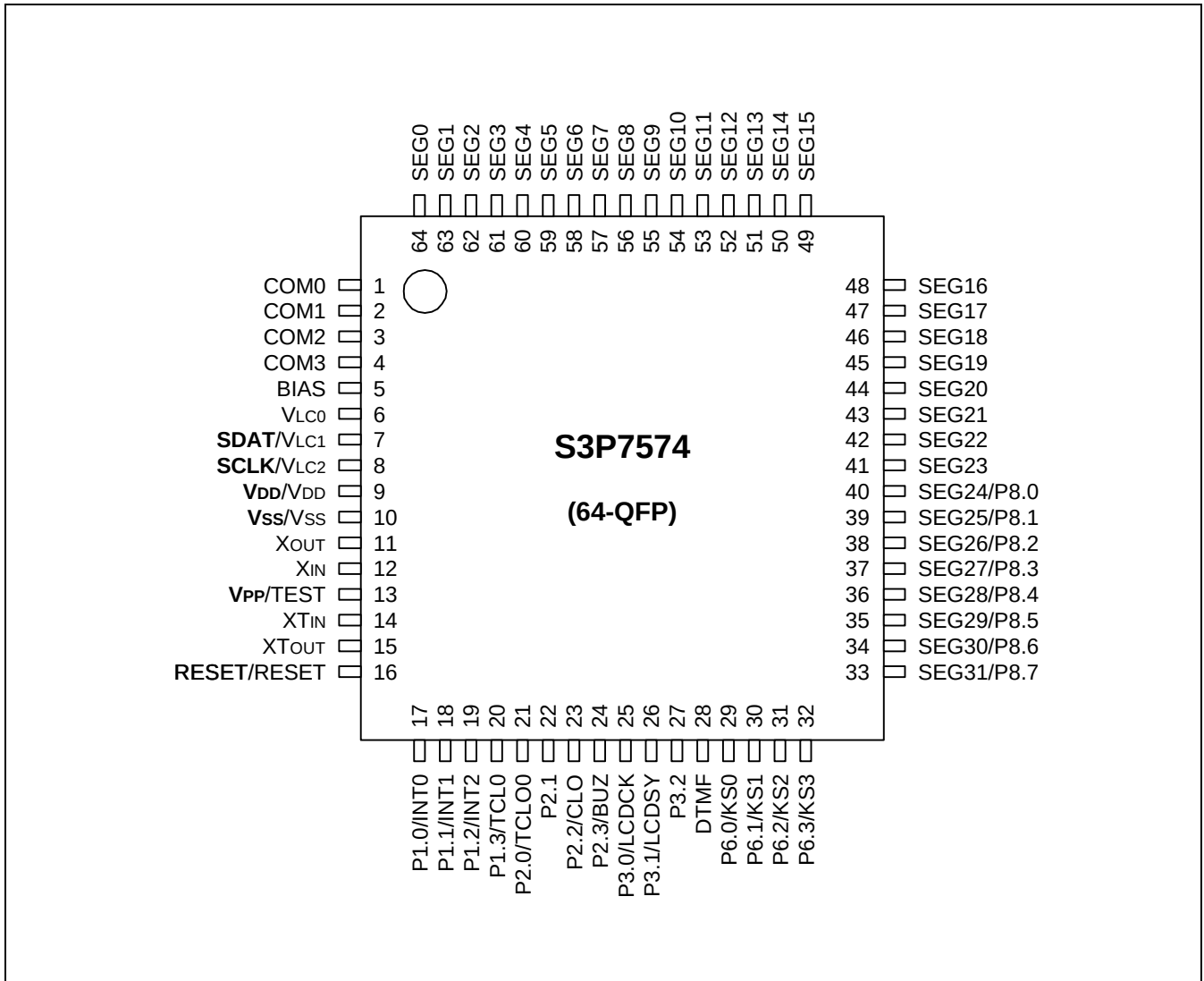


Figure 16-2. S3P7574 Pin Assignments (64-QFP)

Table 16-1. Pin Descriptions Used to Read/Write the EPROM

| Main Chip                        | During Programming               |         |     |                                                                                                                                                                                                     |
|----------------------------------|----------------------------------|---------|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Pin Name                         | Pin Name                         | Pin No. | I/O | Function                                                                                                                                                                                            |
| V <sub>LC1</sub>                 | SDAT                             | 7       | I/O | Serial data pin. Output port when reading and input port when writing. Can be assigned as a Input/push-pull output port.                                                                            |
| V <sub>LC2</sub>                 | SCLK                             | 8       | I/O | Serial clock pin. Input only pin.                                                                                                                                                                   |
| TEST                             | V <sub>PP</sub> (TEST)           | 13      | I   | Power supply pin for EPROM cell writing (indicates that OTP enters into the writing mode). When 12.5 V is applied, OTP is in writing mode and when 5 V is applied, OTP is in reading mode. (Option) |
| RESET                            | RESET                            | 16      | I   | Chip initialization                                                                                                                                                                                 |
| V <sub>DD</sub> /V <sub>SS</sub> | V <sub>DD</sub> /V <sub>SS</sub> | 9/10    | I   | Logic power supply pin. V <sub>DD</sub> should be tied to + 5 V during programming.                                                                                                                 |

Table 16-2. Comparison of S3P7574 and S3C7574 Features

| Characteristic                       | S3P7574                                                | S3C7574                                               |
|--------------------------------------|--------------------------------------------------------|-------------------------------------------------------|
| Program Memory                       | 4-Kbyte EPROM                                          | 4-Kbyte mask ROM                                      |
| Operating Voltage (V <sub>DD</sub> ) | 2.0 V to 5.5 V at 4.19 MHz<br>1.8 V to 5.5 V at 3 MHz  | 2.0 V to 5.5 V at 4.19 MHz<br>1.8 V to 5.5 V at 3 MHz |
| OTP Programming Mode                 | V <sub>DD</sub> = 5 V, V <sub>PP</sub> (TEST) = 12.5 V | —                                                     |
| Pin Configuration                    | 64 QFP                                                 | 64 QFP                                                |
| EPROM Programmability                | User Program 1 time                                    | Programmed at the factory                             |

## OPERATING MODE CHARACTERISTICS

When 12.5 V is supplied to the V<sub>PP</sub> (TEST) pin of the S3P7574, the EPROM programming mode is entered. The operating mode (read, write, or read protection) is selected according to the input signals to the pins listed in Table 16-3 below.

Table 16-3. Operating Mode Selection Criteria

| V <sub>DD</sub> | V <sub>pp</sub> (TEST) | REG/ MEM | Address (A15–A0) | R/W | Mode                  |
|-----------------|------------------------|----------|------------------|-----|-----------------------|
| 5 V             | 5 V                    | 0        | 0000H            | 1   | EPROM read            |
|                 | 12.5 V                 | 0        | 0000H            | 0   | EPROM program         |
|                 | 12.5 V                 | 0        | 0000H            | 1   | EPROM verify          |
|                 | 12.5 V                 | 1        | 0E3FH            | 0   | EPROM read protection |

**NOTE:** "0" means low level; "1" means high level.

Table 16-4. D.C. Electrical Characteristics

(T<sub>A</sub> = –40 °C to +85 °C, V<sub>DD</sub> = 1.8 V to 5.5 V)

| Parameter                   | Symbol            | Conditions                                                                                               | Min                  | Typ | Max                 | Units |
|-----------------------------|-------------------|----------------------------------------------------------------------------------------------------------|----------------------|-----|---------------------|-------|
| Input high voltage          | V <sub>IH1</sub>  | All input pins except those specified below for V <sub>IH2</sub> , V <sub>IH3</sub>                      | 0.7 V <sub>DD</sub>  | –   | V <sub>DD</sub>     | V     |
|                             | V <sub>IH2</sub>  | Ports 1, 6, and RESET                                                                                    | 0.8 V <sub>DD</sub>  | –   | V <sub>DD</sub>     |       |
|                             | V <sub>IH3</sub>  | X <sub>IN</sub> , X <sub>OUT</sub> , and XT <sub>IN</sub>                                                | V <sub>DD</sub> –0.1 | –   | V <sub>DD</sub>     |       |
| Input low voltage           | V <sub>IL1</sub>  | Ports 2 and 3                                                                                            | –                    | –   | 0.3 V <sub>DD</sub> | V     |
|                             | V <sub>IL2</sub>  | Ports 1, 6 and RESET                                                                                     | –                    | –   | 0.2 V <sub>DD</sub> |       |
|                             | V <sub>IL3</sub>  | X <sub>IN</sub> , X <sub>OUT</sub> , and XT <sub>IN</sub>                                                | –                    | –   | 0.1                 |       |
| Output high voltage         | V <sub>OH1</sub>  | V <sub>DD</sub> = 4.5 V to 5.5 V<br>I <sub>OH</sub> = –1 mA<br>Ports 2, 3, 6 and BIAS                    | V <sub>DD</sub> –1.0 | –   | –                   | V     |
|                             | V <sub>OH2</sub>  | V <sub>DD</sub> = 4.5 V to 5.5 V<br>I <sub>OH</sub> = –100 μA Port 8 only                                | V <sub>DD</sub> –2.0 | –   | –                   |       |
| Output low voltage          | V <sub>OL1</sub>  | V <sub>DD</sub> = 4.5 V to 5.5 V<br>I <sub>OL</sub> = 15 mA, Ports 2, 3, 6                               | –                    | 0.4 | 2                   | V     |
|                             | V <sub>OL2</sub>  | V <sub>DD</sub> = 4.5 V to 5.5 V<br>I <sub>OL</sub> = 100 μA; Port 8 only                                | –                    | –   | 1                   |       |
| Input high leakage current  | I <sub>LIH1</sub> | V <sub>IN</sub> = V <sub>DD</sub><br>All input pins except those specified below for I <sub>LIH2</sub>   | –                    | –   | 3                   | μA    |
|                             | I <sub>LIH2</sub> | V <sub>IN</sub> = V <sub>DD</sub><br>X <sub>IN</sub> , X <sub>OUT</sub> and XT <sub>IN</sub>             | –                    | –   | 20                  |       |
| Input low leakage current   | I <sub>LIL1</sub> | V <sub>IN</sub> = 0 V<br>All input pins except X <sub>IN</sub> , X <sub>OUT</sub> , and XT <sub>IN</sub> | –                    | –   | –3                  | μA    |
|                             | I <sub>LIL2</sub> | V <sub>IN</sub> = 0 V<br>X <sub>IN</sub> , X <sub>OUT</sub> , and XT <sub>IN</sub>                       | –                    | –   | –20                 |       |
| Output high leakage current | I <sub>LOH1</sub> | V <sub>OUT</sub> = V <sub>DD</sub><br>All output pins                                                    | –                    | –   | 3                   | μA    |
| Output low leakage current  | I <sub>LOL</sub>  | V <sub>OUT</sub> = 0 V<br>All output pins                                                                | –                    | –   | –3                  |       |

Table 16-4. D.C. Electrical Characteristics (Continued)

(T<sub>A</sub> = -40 °C to +85 °C, V<sub>DD</sub> = 1.8 V to 5.5 V)

| Parameter                       | Symbol           | Conditions                                                                                         | Min                          | Typ                 | Max                          | Units |
|---------------------------------|------------------|----------------------------------------------------------------------------------------------------|------------------------------|---------------------|------------------------------|-------|
| Pull-up resistor                | R <sub>L1</sub>  | V <sub>IN</sub> = 0 V; V <sub>DD</sub> = 5 V<br>Ports 1, 2, 3, 6                                   | 25                           | 50                  | 100                          | KΩ    |
|                                 |                  | V <sub>DD</sub> = 3 V                                                                              | 50                           | 100                 | 200                          |       |
|                                 | R <sub>L2</sub>  | V <sub>IN</sub> = 0 V; V <sub>DD</sub> = 5 V<br>RESET                                              | 100                          | 250                 | 400                          |       |
|                                 |                  | V <sub>DD</sub> = 3 V                                                                              | 200                          | 500                 | 800                          |       |
| LCD voltage dividing resistor   | R <sub>LCD</sub> | T <sub>A</sub> = 25 °C                                                                             | 100                          | 150                 | 200                          |       |
| COM output impedance            | R <sub>COM</sub> | V <sub>DD</sub> = 5 V                                                                              | —                            | 3                   | 6                            |       |
|                                 |                  | V <sub>DD</sub> = 3 V                                                                              |                              | 5                   | 15                           |       |
| SEG output impedance            | R <sub>SEG</sub> | V <sub>DD</sub> = 5 V                                                                              |                              | 3                   | 6                            |       |
|                                 |                  | V <sub>DD</sub> = 3 V                                                                              |                              | 5                   | 15                           |       |
| COM output voltage deviation    | V <sub>DC</sub>  | V <sub>DD</sub> = 5 V (V <sub>LC0</sub> -COM <sub>i</sub> )<br>I <sub>O</sub> = ± 15 μA (I = 0-3)  | —                            | ± 45                | ± 90                         | mV    |
| SEG output voltage deviation    | V <sub>DS</sub>  | V <sub>DD</sub> = 5 V (V <sub>LC0</sub> -SEG <sub>i</sub> )<br>I <sub>O</sub> = ± 15 μA (I = 0-31) | —                            | ± 45                | ± 90                         | mV    |
| V <sub>LC0</sub> Output voltage | V <sub>LC0</sub> | T <sub>A</sub> = 25 °C                                                                             | 0.6 V <sub>DD</sub><br>- 0.2 | 0.6 V <sub>DD</sub> | 0.6 V <sub>DD</sub><br>+ 0.2 | V     |
| V <sub>LC1</sub> Output voltage | V <sub>LC1</sub> | T <sub>A</sub> = 25 °C                                                                             | 0.4 V <sub>DD</sub><br>- 0.2 | 0.4 V <sub>DD</sub> | 0.4 V <sub>DD</sub><br>+ 0.2 |       |
| V <sub>LC2</sub> Output voltage | V <sub>LC2</sub> | T <sub>A</sub> = 25 °C                                                                             | 0.2 V <sub>DD</sub><br>- 0.2 | 0.2 V <sub>DD</sub> | 0.2 V <sub>DD</sub><br>+ 0.2 |       |

Table 16-4. D.C. Electrical Characteristics (Continued)

(T<sub>A</sub> = -40 °C to +85 °C, V<sub>DD</sub> = 1.8 V to 5.5 V)

| Parameter                     | Symbol                          | Conditions                                                                                                                           |                     | Min | Typ        | Max        | Units |  |
|-------------------------------|---------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|---------------------|-----|------------|------------|-------|--|
| Supply Current <sup>(1)</sup> | I <sub>DD1</sub> <sup>(2)</sup> | Main operating:<br>V <sub>DD</sub> = 5 V ± 10 %<br>CPU = f <sub>x</sub> /4<br>SCMOD = 0000B<br>Crystal oscillator<br>C1 = C2 = 22 pF | 6.0 MHz<br>4.19 MHz | —   | 3.5<br>2.5 | 8<br>5.5   | mA    |  |
|                               |                                 | V <sub>DD</sub> = 3 V ± 10 %                                                                                                         | 6.0 MHz<br>4.19 MHz |     | 1.6<br>1.2 | 4<br>3     |       |  |
|                               | I <sub>DD2</sub> <sup>(2)</sup> | Main idle mode;<br>V <sub>DD</sub> = 5 V ± 10%<br>CPU = f <sub>x</sub> /4<br>SCMOD =0000B<br>Crystal oscillator<br>C1 = C2 = 22 pF   | 6.0 MHz<br>4.19 MHz | —   | 1<br>0.9   | 2.5<br>2   |       |  |
|                               |                                 | V <sub>DD</sub> = 3 V ± 10%                                                                                                          | 6.0 MHz<br>4.19 MHz |     | 0.5<br>0.4 | 1.0<br>0.8 |       |  |
|                               | I <sub>DD3</sub>                | Sub operating:<br>V <sub>DD</sub> = 3 V ± 10 %<br>CPU = f <sub>xt</sub> /4,<br>SCMOD = 1001B<br>32 kHz crystal oscillator            |                     | —   | 15         | 30         | μA    |  |
|                               | I <sub>DD4</sub>                | Sub idle mode:<br>V <sub>DD</sub> = 3 V ± 10 %<br>CPU = f <sub>xt</sub> /4, SCMOD = 1001B<br>32 kHz crystal oscillator               |                     | —   | 6          | 15         |       |  |
|                               | I <sub>DD5</sub>                | Stop mode:<br>V <sub>DD</sub> = 5 V ± 10 %<br>CPU=f <sub>xt</sub> /4, SCMOD = 1101B                                                  |                     | —   | 0.5        | 3          |       |  |
|                               | I <sub>DD6</sub> <sup>(3)</sup> | Stop mode:<br>V <sub>DD</sub> = 5 V ± 10%<br>CPU = f <sub>x</sub> /4, SCMOD = 0100B                                                  |                     |     |            |            |       |  |

**NOTES:**

1. D.C. electrical values for supply current (I<sub>DD1</sub> to I<sub>DD6</sub>) do not include current drawn through internal pull-up resistors and through LCD voltage dividing resistors.
2. Data includes the power consumption for sub-system clock oscillation.
3. When the system clock mode register, SCMOD, is set to 0100B, the sub-system clock oscillation stops. The main-system clock oscillation stops by the STOP instruction.



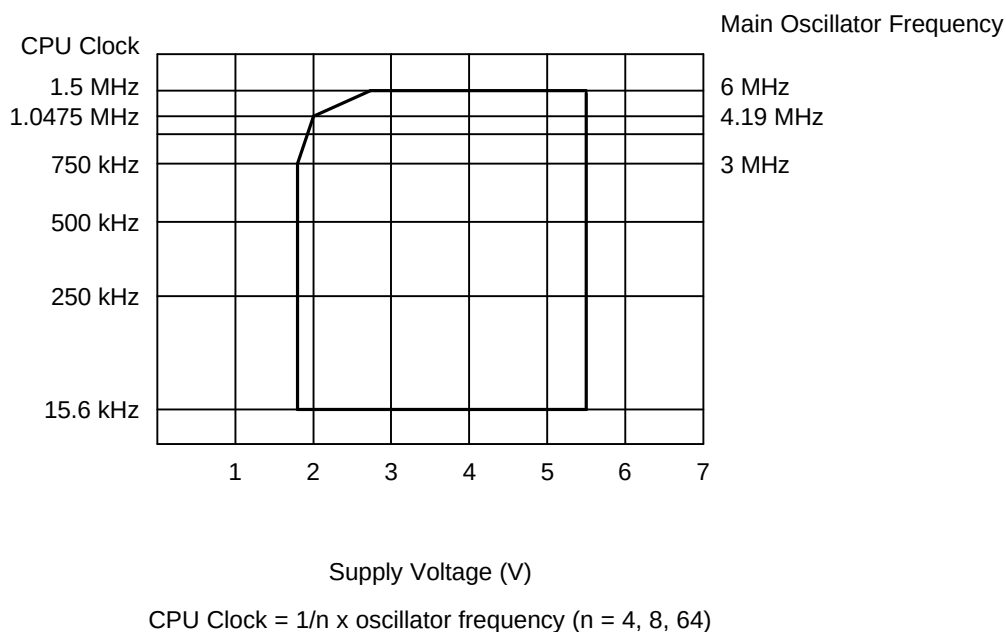
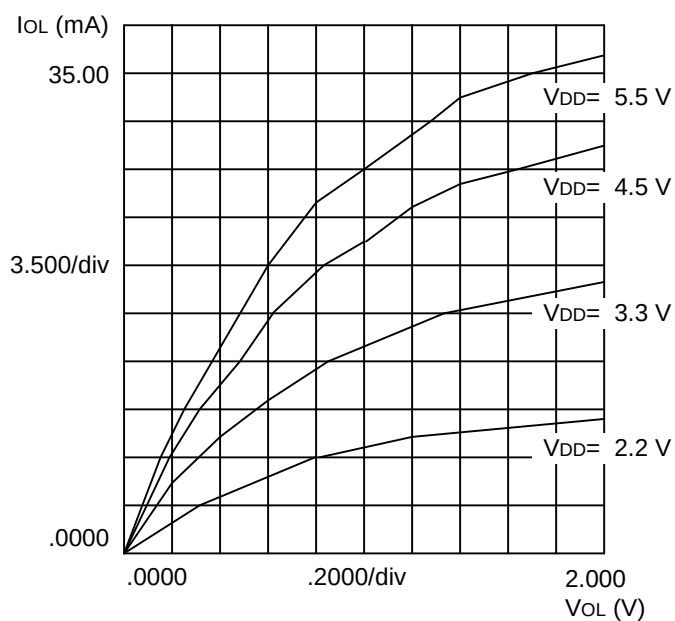


Figure 16-3. Standard Operating Voltage Range

Figure 16-4. Port 2  $I_{OL}$  vs  $V_{OL}$  Curve